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## **SCAN921260**

# X6 1:10 Deserializer with IEEE 1149.1 (JTAG) and at-speed BIST

## **General Description**

The SCAN921260 integrates six deserializer devices into a single chip. The SCAN921260 can simultaneously deserialize up to six data streams that have been serialized by the National Semiconductor SCAN921023 Bus LVDS serializer. The device also includes a seventh serial input channel that serves as a redundant input.

Each deserializer block in the SCAN921260 operates independently with its own clock recovery circuitry and lock-detect signaling.

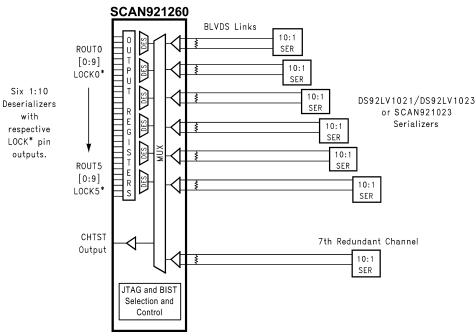
The SCAN921260 uses a single +3.3V power supply with an estimated power dissipation of 1.2W at 3.3V with a PRBS-15 pattern. Refer to the Connection Diagrams for packaging information.

## **Features**

- IEEE 1149.1 (JTAG) Compliant and at-speed BIST test modes
- Deserializes one to six BusLVDS input serial data streams with embedded clocks
- Seven selectable serial inputs to support n+1 redundancy of deserialized streams
- Seventh channel has single pin monitor output that reflects input from seventh channel input
- Parallel clock rate up to 66MHz
- On chip filtering for PLL
- High impedance inputs upon power off (V<sub>cc</sub> = 0V)
- Single power supply at +3.3V
- 196-pin LBGA package (Low-profile Ball Grid Array) package
- Industrial temperature range operation: -40 to +85

## **Functional Block Diagram**

## Typical Application



20014702

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## **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V<sub>CC</sub>) -0.3V to +4V
LVCMOS/LVTTL Input Voltage -0.3V to 3.9V
LVCMOS/LVTTL Output Voltage -0.3V to 3.9V
Bus LVDS Receiver Input Voltage -0.3V to 3.9V
Bus LVDS Driver Output Voltage -0.3V to 3.9V
Bus LVDS Output Short Circuit
Duration 10ms
Junction Temperature +150°C

Storage Temperature -65°C to +150°C

Lead Temperature

(Soldering, 10 seconds) +225°C

Max Pkg Power Dissipation Capacity @ 25°C

196L BGA 3.7 W

Package Derating:

196L BGA 29.4 mW/°C above

+25°C

Thermal Resistance:

 $\theta_{JA}$   $$34^{\circ}\text{C/W}$$   $\theta_{JC}$   $$8^{\circ}\text{C/W}$$ 

ESD Rating:

Human Body Model >2KV Machine Model >750V

# Recommended Operating Conditions

	Min	Nom	Max	Units
Supply Voltage (V <sub>CC</sub> )	3.0	3.3	3.6	V
Operating Free Air Temperature (T <sub>A</sub> )	-40	+25	+85	°C
Clock Rate	20		66	MHz

**Electrical Characteristics** Over recommended operating supply and temperature ranges unless otherwise specified(Note 2)

Symbol	Parameter	meter Conditions		Тур	Max	Units
LVCMOS/	LVTTL DC Specifications: Appli	es to pins in Pin Description tab	le with type (	CMOS Input or	Output	•
V <sub>IH</sub>	High Level Input Voltage	Input Pins	2.0		V <sub>CC</sub>	V
V <sub>IL</sub>	Low Level Input Voltage	Input Pins	GND		0.8	V
$V_{CL}$	Input Clamp Voltage	Input Pins		-0.87	-1.5	V
I <sub>IN</sub>	Input Current	V <sub>in</sub> = 0 or 3.6V, Input Pins	-20		+20	uA
$V_{OH}$	High Level Output Voltage	I <sub>OH</sub> = 6mA, Output Pins	2	3	V <sub>CC</sub>	V
$V_{OL}$	Low Level Output Voltage	I <sub>OL</sub> = 6mA, Output Pins	GND	0.18	0.4	V
$V_{OH}$	High Level Output Voltage	I <sub>OH</sub> = 12mA, TDO Output	2	3	V <sub>cc</sub>	V
$V_{OL}$	Low Level Output Voltage	I <sub>OL</sub> = 12mA, TDO Output	GND	0.18	0.4	V
Ios	Output short Circuit Current	V <sub>out</sub> = 0V, Output Pins	-15	-46	-85	mA
Ios	Output short Circuit Current	V <sub>out</sub> = 0V, TDO Output	-15		-120	mA
I <sub>OZ</sub>	TRI-STATE Output Current	PD* or REN = 0.8V V <sub>out</sub> = 0V or V <sub>CC</sub>	-10	+/-0.2	+10	uA
Bus LVDS	DC specifications: Applies to p	oins in Pin Description table with	n type Bus L\	/DS Inputs		
$V_{TH}$	Differential Threshold High Voltage	VCM = 1.1V (V <sub>RI+</sub> -V <sub>RI-</sub> )		+3	+50	mV
V <sub>TL</sub>	Differential Threshold Low Voltage		-50	-2		mV
I <sub>IN</sub>	Input Current	$V_{in}$ = +2.4V or 0V, $V_{cc}$ = 3.6 or 0V		+/- 1	+10	uA
Supply Cu	urrent					
I <sub>CCR</sub>	Worst Case Supply Current	3.6V, Checker Board Pattern, $C_L = 15pF$ , 66Mhz		600	660	mA
I <sub>CCXR</sub>	Supply Current when Powered Down	PWRDN= 0.8V REN = 0.8V		0.36	1	mA

## **Electrical Characteristics** Over recommended operating supply and temperature ranges unless otherwise specified(Note 2) (Continued)

Symbol	Parameter	Conditions	•	Min	Тур	Max	Units
Timing Re	equirements for REFCLK	•		•			•
t <sub>RFCP</sub>	REFCLK Period			15.15		50	ns
t <sub>RFDC</sub>	REFCLK Duty Cycle			40	50	60	%
t <sub>RFCP</sub> /t <sub>TCP</sub>	Ratio of REFCLK to TCLK			0.95		1.05	
t <sub>RFTT</sub>	REFCLK Transition Time					8	ns
Deserializ	er Switching Characteristics			_			
t <sub>RCP</sub>	RCLK Period	RCLK		15.15		50	ns
t <sub>RDC</sub>	RCLK Duty Cycle	RCLK (Note 7)		45	50	55	%
t <sub>CHTST</sub>	Period of Bus LVDS signal when CHTST is selected by MUX	CHTST (Note 6)		25			ns
t <sub>CLH</sub>	CMOS/TTL Low-to-High Transition Time	C <sub>L</sub> = 15pF			1.7	6	ns
t <sub>CHL</sub>	CMOS/TTL High-to-Low Transition Time	C <sub>L</sub> = 15pF			1.6	6	ns
t <sub>ROS</sub>	Rout Data Valid before RCLK	$C_L = 15pF$ , Figure 2		0.35*t <sub>RCP</sub>			ns
t <sub>ROH</sub>	Rout Data Valid after RCLK	$C_L = 15pF$ , Figure 2		-0.35*t <sub>RCP</sub>			ns
t <sub>HZR</sub>	High to TRI-STATE Delay					12	ns
t <sub>LZR</sub>	Low to TRI-STATE Delay	C 15p5 Figure 7				12	ns
t <sub>zhr</sub>	TRI-STATE to High Delay	$C_L = 15pF$ , Figure 7				12	ns
t <sub>ZLR</sub>	TRI-STATE to Low Delay					12	ns
t <sub>DD</sub>	Deserializer Delay	Figure 1		1.75*t <sub>RCP</sub> +3	1.75*t <sub>RCP</sub> +7	1.75*t <sub>RCP</sub> +10.5	ns
i	Deserializer PLL LOCK Time	Figure 3 66Mhz				2	us
t <sub>DSR1</sub>	from PWRDN (with SYNCPAT)	(Note 4) 20Mhz				10	us
	Deserializer PLL Lock Time from	Figure 4 66Mhz				1.5	us
t <sub>DSR2</sub>	SYNCPAT	(Note 4)	20Mhz			5	us
t <sub>RNMI-R</sub>	Ideal Strobe Window Right	66Mhz, Figure 10	•			+400	ps
t <sub>RNMI-L</sub>	Ideal Strobe Window Left	66Mhz, Figure 10		-400			ps

**Note 1:** "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" specifies conditions of device operation.

Note 3: Current into the device pins is defined as positive. Current out of device pins is defined as negative. Voltage are referenced to ground except VOD, VTH and VTL which are differential voltages.

Note 4: For the purpose of specifying deserializer PLL performance  $t_{DSR1}$  and  $t_{DSR2}$  are specified with the REFCLK running and stable, and specific conditions of the incoming data stream (SYNCPATs).  $t_{DSR1}$  is the time required for the deserializer to indicate lock upon power-up or when leaving the power-down mode.  $t_{DSR2}$  is the time required to indicate lock for the powered-up and enabled deserializer when the input (RI+ and RI-) conditions change from not receiving data to receiving synchronization patterns (SYNCPATs). The time to lock to random data is dependent upon the incoming data.

Note 5: t<sub>RNM</sub> is a measure of how much phase noise (jitter)the deserializer can tolerate in the incoming data stream before bit errors occur. The Deserializer Noise Margin is Guaranteed By Design (GBD) using statistical analysis.

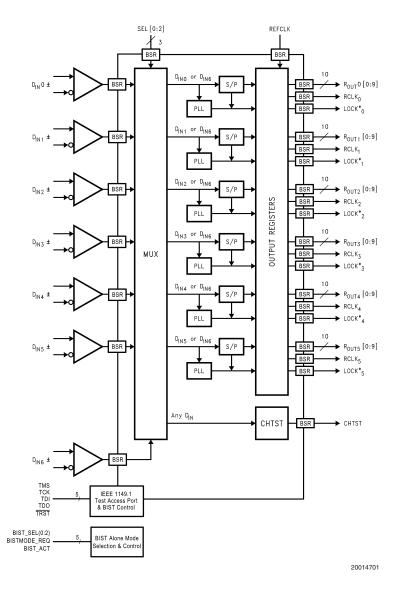
Note 6: Because the Bus LVDS serial data stream is not decoded, the maximum frequency of the CHTST output driver could be exceeded if the data stream were switched to CHTST. The maximum frequency of the BUS LVDS input should not exceed the parallel clock rate.

Note 7: Guaranteed By Design (GBD) using statistical analysis.

Note 2: Typical values are given for Vcc = 3.3V and TA =25°C

#### **SCAN Circuitry Timing Requirements** Symbol **Parameter Conditions** Min Max Units Тур $f_{\mathsf{MAX}}$ Maximum TCK Clock $R_L = 500\Omega$ , $C_L = 35 pF$ 25.0 50.0 MHz Frequency TDI to TCK, H or L $\mathsf{t}_{\mathsf{S}}$ 1.0 ns $t_{\rm H}$ TDI to TCK, H or L 2.0 ns TMS to TCK, H or L 2.5 $t_{\rm S}$ ns TMS to TCK, H or L $\mathsf{t}_{\mathsf{H}}$ 1.5 ns TCK Pulse Width, H or L 10.0 $t_{\text{W}}$ ns TRST Pulse Width, L 2.5 $t_{\mathsf{W}}$ ns Recovery Time, TRST to 2.0 $t_{\mathsf{REC}}$ ns TCK

## **Block Diagram**



## **Control Pins Truth Table**

PWRDN	REN	SEL2	SEL1	SEL0	Rout	CHTST	LOCK[0:5]	RCLK[0:5]
Н	Н	L	L	L	Din6 Decoded to	Din0 (not	Active(Note 9)	Active(Notes 10,
					Rout 0 (0:9)(Note	decoded)		11)
					11)			
Н	Н	L	L	Н	Din6 Decoded to	Din1 (not	Active(Note 9)	Active(Notes 10,
					Rout 1 (0:9)(Note	decoded)		11)
					11)			
Н	Н	L	Н	L	Din6 Decoded to	Din2 (not	Active(Note 9)	Active(Notes 10,
					Rout 2 (0:9)(Note	decoded)		11)
					11)			
Н	Н	L	Н	Н	Din6 Decoded to	Din3 (not	Active(Note 9)	Active(Notes 10,
					Rout 3 (0:9)(Note	decoded)		11)
					11)			
Н	Н	Н	L	L	Din6 Decoded to	Din4 (not	Active(Note 9)	Active(Notes 10,
					Rout 4 (0:9)(Note	decoded)		11)
					11)			
H	Н	Н	L	Н	Din6 Decoded to	Din5 (not	Active(Note 9)	Active(Notes 10,
					Rout 5 (0:9)(Note	decoded)		11)
					11)			
Н	Н	Н	Н	L	Din6 is not	Z	Active(Note 9)	Active(Notes 10,
					Decoded			11)
Н	Н	Н	Н	Н	Din6 is not	Din6 (not	Active(Note 9)	Active(Notes 10,
					Decoded	decoded)		11)
L	Х	Х	Х	Х	Z	Z	Z	Z
Н	L	Х	Х	Х	Z	Z	Active(Note 9)	Z

Note 8: The routing of the Din inputs to the Deserializers and to the CHTST outputs are dependent on the states of SEL [0:2].

 $\textbf{Note 9:} \ \overline{\mathsf{LOCK}} \ \mathsf{Active} \ \mathsf{indicates} \ \mathsf{that} \ \mathsf{the} \ \overline{\mathsf{LOCK}} \ \mathsf{output} \ \mathsf{will} \ \mathsf{reflect} \ \mathsf{the} \ \mathsf{state} \ \mathsf{of} \ \mathsf{it's} \ \mathsf{respective} \ \mathsf{Deserializer} \ \mathsf{with} \ \mathsf{regard} \ \mathsf{to} \ \mathsf{the} \ \mathsf{selected} \ \mathsf{data} \ \mathsf{stream}.$ 

Note 10: RCLK Active indicates that the RCLK will be running if the Deserializer is locked.

Note 11: Rout n[0:9] and RCLK [0:5] are Tri-Stated when  $\overline{\text{LOCKn}}$ [0:5] is High.

## **Timing Diagrams**

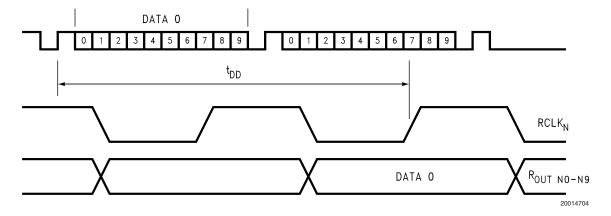


FIGURE 1. Deserializer Delay  $t_{\rm DD}$ 

## Timing Diagrams (Continued)

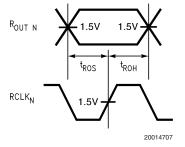


FIGURE 2. Output Timing  $t_{\mbox{\scriptsize ROS}}$  and  $t_{\mbox{\scriptsize ROH}}$ 

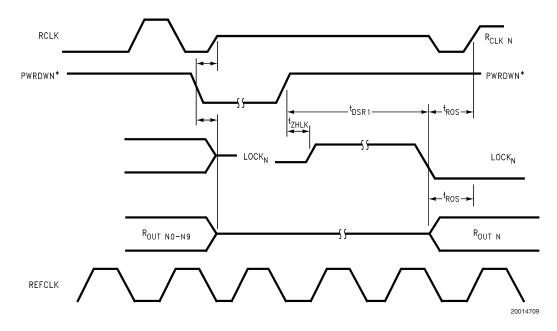


FIGURE 3. Locktime from PWRDN\*  $t_{\rm DSR1}$ 

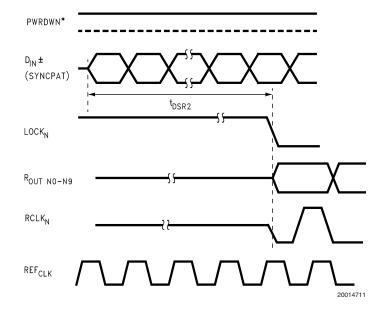


FIGURE 4. Locktime to SYNCPAT  $t_{\ensuremath{\mathsf{DSR2}}}$ 

## Timing Diagrams (Continued)

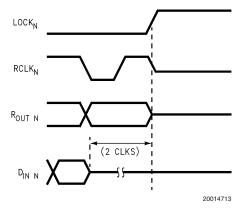
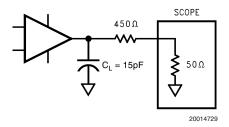
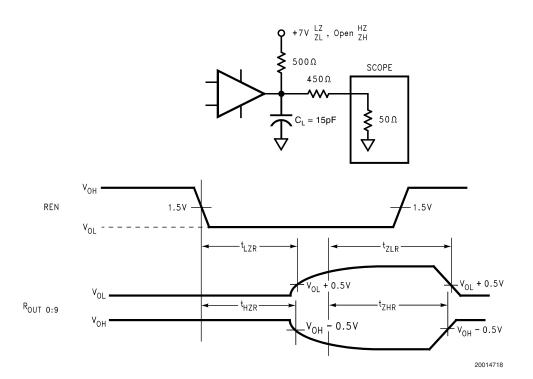


FIGURE 5. Unlock



Note:  $C_L$  includes Jig and stray capacitance. For the TDO output,  $C_L$  = 35pF.

FIGURE 6. Output load for Timing and Switching Characteristics



Note:  $C_L$  includes Jig and stray capacitance. For the TDO output,  $C_L$  = 35pF.

FIGURE 7. Deserializer TRI-STATE Test Circuit and Timing

## **Application Information**

#### USING THE SCAN921023 and SCAN921260

The SCAN921260 combines six 1:10 deserializers into a single chip. Each of the six deserializers accepts a BusLVDS data stream up to 660 Mbps from National Semiconductor's SCAN921023 Serializer. The deserializers then recover the embedded two clock bits and data to deliver the resulting 10-bit wide words to the output. A seventh serial data input provides n+1 redundancy capability. The user can program the seventh input to be an alternative input to any of the six deserializers. Whichever input is replaced by the seventh input is then routed to the CHANNEL TEST (CHTST) pin on receiver output port. The Deserializer uses a separate reference clock (REFCLK) and an onboard PLL to extract the clock information from the incoming data stream and then deserialize the data. The Deserializer monitors the incoming clock information, determines lock status, and asserts the LOCKn output high when loss of lock occurs.

Each of the 6 channels acts completely independent of each other. Each independent channel has outputs for a 10-bit wide data word, the recovered clock out, and the lock-detect output.

The SCAN921260 has three operating states: Initialization, Data Transfer, and Resynchronization. In addition, there are two passive states: Powerdown and TRI-STATE.

The following sections describe each operating mode and passive state.

#### INITIALIZATION

Before the SCAN921260 receives and deserializes data, it and the transmitting serializer devices must initialize the link. Initialization refers to synchronizing the Serializer's and the Deserializer's PLL's to local clocks. The local clocks must be the same frequency or within a specified range if from different sources. After all devices synchronize to local clocks, the Deserializers synchronize to the Serializers as the second and final initialization step.

Step 1: After applying power to the Deserializer, the outputs are held in TRI-STATE and the on-chip power-sequencing circuitry disables the internal circuits. When  $V_{\rm cc}$  reaches  $V_{\rm cc}$ OK (2.1V), the PLL in each deserializer begins locking to the local clock (REFCLK). A local on-board oscillator or other source provides the specified clock input to the REFCLK pin.

Step 2: The Deserializer PLL must synchronize to the Serializer to complete the initialization. Refer to the Serializer data sheet for the proper operation during this step of the Initialization State. The Deserializer identifies the rising clock edge in a synchronization pattern or random data and after 80 clock cycles will synchronize to the data stream from the serializer. At the point where the Deserializer's PLL locks to the embedded clock, the  $\overline{LOCKn}$  pin goes low and valid data appears on the output. Note that this differs from previous deserializers where the  $\overline{LOCKn}$  signal was not synchronous to valid data appearing on the outputs.

#### **DATA TRANSFER**

After initialization, the serializer transfers data to the deserializers. The serial data stream includes a start and stop bit appended by the serializer, which frame the ten data bits. The start bit is always high and the stop bit is always low. The start and stop bits also function as clock bits embedded in the serial stream.

The Serializer transmits the data and clock bits (10+2 bits) at 12 times the TCLK frequency. For example, if TCLK is 40

MHz, the serial rate is 40 X 12 = 480 Mbps. Since only 10 bits are from input data, the serial 'payload' rate is 10 times the TCLK frequency. For instance, if TCLK = 40 MHz, the payload data is 40 X 10 = 400 Mbps. TCLK is provided by the data source and must be in the range 20 MHz to 40 MHz nominal.

When one of six Deserializer channels synchronizes to the input from a Serializer, it drives its LOCKn pin low and synchronously delivers valid data on the output. The Deserializer locks to the embedded clock, uses it to generate multiple internal data strobes, and drives the embedded clock to the RCLKn pin. The RCLKn is synchronous to the data on the ROUT[n0:n9] pins. While LOCKn is low, data on ROUT [n0:n9] is valid. Otherwise, ROUT[n0:n9] is invalid.

All ROUT,  $\overline{\mathsf{LOCK}}$ , and RCLK signals will drive a minimum of three CMOS input gates (15pF load) with a 66 MHz clock. This amount of drive allows bussing outputs of two Deserializers and a destination ASIC. REN controls TRI-STATE of all the outputs.

The Deserializer input pins are high impedance during Powerdown ( $\overline{PWRDN}$  low) and power-off ( $V_{cc}=0V$ ).

#### RESYNCHRONIZATION

Whenever one of the six Deserializers loses lock, it will automatically try to resynchronize. For example, if the embedded clock edge is not detected two times in succession, the PLL loses lock and the  $\overline{\text{LOCKn}}$  pin is driven high. The system must monitor the  $\overline{\text{LOCKn}}$  pin to determine when data is valid.

The user has the choice of allowing the deserializer to resynch to the data stream or to force synchronization by pulsing the Serializer SYNC1 or SYNC2 pin. This scheme is left up to the user discretion. One recommendation is to provide a feedback loop using the  $\overline{\text{LOCKn}}$  pin itself to control the sync request of the Serializer (SYNC1 or SYNC2). Dual SYNC pins are given for multiple control in a multi-drop application.

#### **POWERDOWN**

The Powerdown state is a low power sleep mode that the Serializer and Deserializer typically occupy while waiting for initialization, or to reduce power consumption when no data is transferred. The Deserializer enters Powerdown when PWRDN is driven low. In Powerdown, the PLL stops and the outputs go into TRI-STATE, which reduces supply current to the microamp range. To exit Powerdown, the system drives PWRDN high.

Upon exiting Powerdown, the Deserializer enters the Initialization state. The system must then allow time to Initialize before data transfer can begin.

### TRI-STATETRI-STATE®

When the system drives REN pin low, the Deserializer enters TRI-STATE. This will TRI-STATE the receiver output pins (ROUT[00:59]) and RCLK[0:5]. When the system drives REN high, the Deserializer will return to the previous state as long as all other control pins remain static (PWRDN).

### **IEEE 1149.1 TEST MODES**

The SCAN921260 features interconnect test access that is compliant to the IEEE 1149.1 Standard for Boundary Scan Test (JTAG). All digital TTL I/O's on the device are accessible using IEEE 1149.1, and entering this test mode will override

## **Application Information** (Continued)

all input control cases including PWRDN and REN. In addition to the 4 required Test Access Port (TAP) signals of TMS, TCK, TDI, and TDO, TRST is provided for test reset.

To supplement the test coverage provided by the IEEE 1149.1 test access to the digital TTL pins, the SCAN921260 has two instructions to test the LVDS interconnects. The first is EXTEST. This is implemented at LVDS levels and is only intended as a go no-go test (e.g. missing cables). The second method is the RUNBIST instruction. It is an "at-system-speed" interconnect test. It is executed in approximately 33mS with a system clock speed of 66MHz. There are 12 bits in the RX BIST data register for notification of PASS/FAIL and TEST\_COMPLETE; two bits for each of the six channels. The RX BIST register is defined as (from MSB to LSB):

[BIST COMPLETE for Channel 6, BIST PASS/FAIL for Channel 6, BIST COMPLETE for Channel 5, BIST PASS/FAIL for Channel 5, BIST COMPLETE for Channel 4, BIST PASS/FAIL for Channel 4, BIST COMPLETE for Channel 3, BIST PASS/FAIL for Channel 3, BIST COMPLETE for Channel 2, BIST PASS/FAIL for Channel 2, BIST COMPLETE for Channel 1, BIST PASS/FAIL for Channel 1]

A "pass" indicates that the BER (Bit-Error-Rate) is better than  $10^{-7}$ . This is a minimum test, so a "fail" indication means that the BER is higher than  $10^{-7}$ .

The BIST features of the SCAN921260 six (6) channel deserializer are compatible with the BIST features on the SCAN921023 Serializer.

An important detail is that once both devices have the RUN-BIST instruction loaded into their respective instruction registers, both devices must move into the RTI state within 4K system clocks (At a system CLK of 66Mhz and TCK of 1MHz this allows for 66 TCK cycles). This is not a concern when both devices are on the same scan chain or LSP, however, it can be a problem with some multi-drop devices. This test mode has been simulated and verified using National's SCANSTA111.

Typical applications of 1149.1 are based around TTL-type inputs. With the introduction of 1149.1 into LVDS there have been many hurdles to overcome. One issue is that TTL inputs and outputs do not require bias circuits and are always on when power is applied. In the case of LVDS, there are many circuits required to make the inputs and outputs achieve their tight tolerances. These circuits require settle time once power is applied to ensure they function properly. These circuits are also the largest users of power within the device. To reduce power in standby, these devices have a PWRDN pin to shut these circuits down. There is also a REN pin that enables/disables the TTL outputs.

In the case of the 1149.1 functionality, these circuits need appropriate time to stabilize before they can be utilized. To achieve stability, these circuits are powered up when the TAP controller state machine is not in the *Test-Logic-Reset* state. The time that it takes a TAP to traverse from *Test-Logic-Reset* to *Capture-Data-Register* running at 25MHz is sufficient to allow these circuits to stabilize.

Once the TAP has left *Test-Logic-Reset*, the internal value of PWRDN is overridden and the device is powered up. This includes all fore mentioned circuits as well as all outputs. If an application requires that the outputs are to remain disabled during 1149.1 test, use REN and not PWRDN.

KNOWN ERRATA: On the SCAN921260 only the overridden value of PWRDN ("1") is captured during all 1149.1 tests and not the external value as seen on the pin.

#### **BIST ALONE TEST MODES**

The SCAN921260 also supports a BIST Alone feature which can be run without enabling the JTAG TAP controller. This feature provides the ability to run continuos BER testing on all channels, or on individual channels without affecting live traffic on other channels. The ability to run the BERT while adjacent channels are carrying normal traffic is a useful tool to determine how normal traffic will affect BER on any given channel.

The BIST Alone features can be accessed using the 5 pins defined as BIST\_SEL0, BIST\_SEL1, BIST\_SEL2, BIST\_ACT, and BISTMODE\_REQ.

BIST\_ACT activates the BIST Alone mode. The BIST Alone mode will continue until deactivated by the BIST\_ACT pin. The BIST\_ACT input must be high or low for 4 or more clock cycles in order to activate or deactivate the BIST Alone mode. The BIST\_ACT input is pulled low internally.

BISTMODE\_REQ is used to select either gross error reporting or a specific output error report. When the BIST Alone mode is active, the LOCK(1:6) output for all channels running BIST Alone will go low, and ROUT(0:9) reports any error. When BISTMODE\_REQ is low the error reporting is set to Gross Mode, and whenever a bit contains one or more errors, ROUT(0:9) for that channel goes high and stays high until deactivation by the BIST\_ACT input. When BISTMODE\_REQ is high, the output error reporting is set to Bit Error mode. Whenever any data bit contains an error, the data output for that corresponding bit goes high. The default is Gross Error mode.

The three BIST\_SELn inputs determine which channel is in BIST Alone mode according to the following table:

# **Application Information** (Continued) **BIST Alone Mode Selection**

BIST_ACT	BIST_SEL2	BIST_SEL1	BIST_SEL0	BIST for Channel
1	0	0	0	0
1	0	0	1	1
1	0	1	0	2
1	0	1	1	3
1	1	0	0	4
1	1	0	1	5
1	1	1	0	All Channels
1	1	1	1	IDLE
0	X	Х	Х	IDLE

#### **POWER CONSIDERATIONS**

An all CMOS design of the Deserializer makes it an inherently low power device.

#### **POWERING UP THE DESERIALIZER**

The SCAN921260 can be powered up at any time by following the proper sequence. The REFCLK input can be running before the Deserializer powers up, and it must be running in order for the Deserializer to lock to incoming data. The Deserializer outputs will remain in TRI-STATE until the Deserializer detects data transmission at its inputs and locks to the incoming data stream.

#### TRANSMITTING DATA

Once you power up the Deserializer, it must be phase locked to the transmitter to transmit data. Phase locking occurs when the Deserializer locks to incoming data or when the Serializer sends sync patterns. The Serializer sends SYNC patterns whenever the SYNC1 or SYNC2 inputs are high. The LOCKn output of the Deserializer remains high until it has locked to the incoming data stream. Connecting the LOCKn output of the Deserializer to one of the SYNC inputs of the Serializer will guarantee that enough SYNC patterns are sent to achieve Deserializer lock.

The Deserializer can also lock to incoming data by simply powering up the device and allowing the "random lock" circuitry to find and lock to the data stream.

While the Deserializer LOCKn output is low, data at the Deserializer outputs (ROUT0-9) are valid, except for the specific case of loss of lock during transmission which is further discussed in the "Recovering from LOCK Loss" section below.

### **NOISE MARGIN**

The Deserializer noise margin is the amount of input jitter (phase noise) that the Deserializer can tolerate and still reliably receive data. Various environmental and systematic factors include:

Serializer: TCLK jitter,  $V_{\text{CC}}$  noise (noise bandwidth and out-of-band noise)

Media: ISI, Large  $V_{CM}$  shifts Deserializer:  $V_{CC}$  noise

#### RECOVERING FROM LOCK LOSS

In the case where the Deserializer loses lock during data transmission, up to 1 cycle of data that was previously received can be invalid. This is due to the delay in the lock detection circuit. The lock detect circuit requires that invalid

clock information be received 2 times in a row to indicate loss of lock. Since clock information has been lost, it is possible that data was also lost during these cycles. Therefore, after the Deserializer relocks to the incoming data stream and the Deserializer LOCKn pin goes low, at least one previous data cycle should be suspect for bit errors.

The Deserializer can relock to the incoming data stream by making the Serializer resend SYNC patterns, as described above, or by random locking, which can take more time, depending on the data patterns being received.

#### **HOT INSERTION**

All the BusLVDS devices are hot pluggable if you follow a few rules. When inserting, ensure the Ground pin(s) makes contact first, then the VCC pin(s), and then the I/O pins. When removing, the I/O pins should be unplugged first, then the VCC, then the Ground. Random lock hot insertion is illustrated in *Figure 10*.

## PCB LAYOUT AND POWER SYSTEM CONSIDERATIONS

Circuit board layout and stack-up for the SCAN921260 should be designed to provide noise-free power to the device. Good layout practice will separate high frequency or high level inputs and outputs to minimize unwanted stray noise pickup, feedback and interference. There are a few common practices which should be followed when designing PCB's for Bus LVDS Signaling. Recommended layout practices are:

- Use at least 4 PCB board layers (Bus LVDS signals, ground, power, and TTL signals).
  - Power system performance may be greatly improved by using thin dielectrics (4 to 10 mils) for power/ground sandwiches. This increases the intrinsic capacitance of the PCB power system which improves power supply filtering, especially at high frequencies, and makes the value and placement of external bypass capacitors less critical.
- Keep Serializers and Deserializers as close to the (Bus LVDS port side) connector as possible.

Longer stubs lower the impedance of the bus, increase the load on the Serializer, and lower the threshold margin at the Deserializers. Deserializer devices should be placed much less than one inch from slot connectors. Because transition times are very fast on the Serializer Bus LVDS outputs, reducing stub lengths as much as possible is the best method to ensure signal integrity.

## **Application Information** (Continued)

 Bypass each Bus LVDS device and also use distributed bulk capacitance between power planes.

Surface mount capacitors placed close to power and ground pins work best. External bypass capacitors should include both RF ceramic and tantalum electrolytic types. RF capacitors may use values in the range 0.001  $\mu\text{F}$  to 0.1  $\mu\text{F}$ . Tantalum capacitors may be in the range 2.2  $\mu\text{F}$  to 10  $\mu\text{F}$ . Voltage rating for tantalum capacitors should be at least 5X the power supply voltage being used. Randomly distributed by-pass capacitors should also be used.

Package and pin layout permitting, it is also recommended to use two vias at each power pin as well as all RF bypass capacitor terminals. Dual vias reduce the interconnect inductance between layers by up to half, thereby reducing interconnect inductance and extending the effective frequency range of the bypass components.

- Leave unused Bus LVDS receiver inputs open (floating).
- Isolate TTL signals from Bus LVDS signals.

There are more common practices which should be followed when designing PCBs for BLVDS/LVDS signaling. General application guidelines are available in the LVDS Owner's Manual (www.national.com/lvds). For packaging information on BGA's, please see AN-1126.

#### TRANSMISSION MEDIA

The Serializer and Deserializer can also be used in point-topoint configurations, through PCB trace, or through twisted pair cable. In point-to-point configurations, the transmission media need only be terminated at the receiver end. Please note that in point-to-point configurations, the potential of offsetting the ground levels of the Serializer vs. the Deserializer must be considered. Also, Bus LVDS provides a +/- 1.2V common mode range at the receiver inputs.

#### **FAILSAFE BIASING FOR THE SCAN921260**

The SCAN921260 has internal failsafe biasing and an improved input threshold sensitivity of +/- 50mV versus +/- 100mV for the DS92LV1210 or DS92LV1212. This allows for greater differential noise margin in the SCAN921260. However, in cases where the receiver input is not being actively driven, the increased sensitivity of the SCAN921260 can pickup noise as a signal and cause unintentional locking. For example, this can occur when the input cable is disconnected.

External resistors can be added to the receiver circuit board to prevent noise pick-up. Typically, the non-inverting receiver input is pulled up and the inverting receiver input is pulled down by high value resistors. The pull-up and pull-down resistors (R $_1$  and R $_2$ ) provide a current path through the termination resistor (R $_L$ ) which biases the receiver inputs when they are not connected to an active driver. The value of the pull-up and pull-down resistors should be chosen so that enough current is drawn to provide a +15mV drop across the termination resistor. Please see Figure 8 for the Failsafe Biasing Setup.

The parameter  $t_{\text{RNM}}$  is calculated by first measuring how much of the ideal bit the receiver needs to ensure correct sampling. After determining this amount, what remains of the ideal bit that is available for external sources of noise is called  $t_{\text{RNM}}$ . It is the offset from  $t_{\text{DJIT}(\text{min or max})}$  for the test mask within the eye opening.

The vertical limits of the mask are determined by the SCAN921260 receiver input threshold of +/- 50mV.

Please refer to the eye mask pattern of Figure 9 for a graphic representation of  $t_{\rm DJIT}$  and  $t_{\rm RNM}$ .

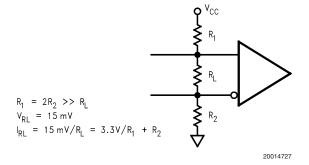


FIGURE 8. Failsafe Biasing Setup

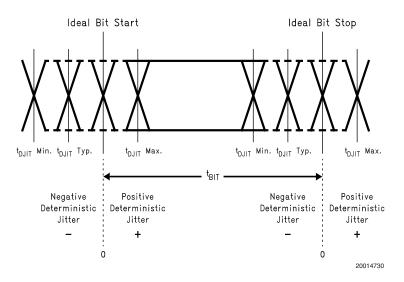
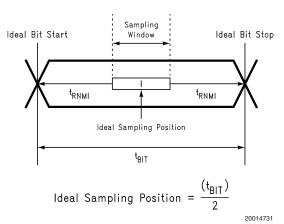


FIGURE 9. Deterministic Jitter and ideal Bit Position



 $t_{RNMI-L}$  is the ideal noise margin on the left of the figure, it is a negative value to indicate early with respect to ideal.  $t_{RNMI-R}$  is the ideal noise margin on the right of the above figure, it is a positive value to indicate late with respect to ideal.

FIGURE 10. Ideal Deserializer Noise Margin ( $t_{\text{RNMI}}$ ) and Sampling Window

## Pin Diagram

## SCAN921260UJB and SCAN921260UJBX (196 pin LBGA)

(A1)	A2	A3	A4	A5	A6	A7	(A8)	(A9)	(A 1 0)	(A 1 1)	(A12)	(A 13)	(A14)
DGND B1	REN B2	R <sub>INO</sub> -	R <sub>INO</sub> +	AGND B5	R <sub>IN2</sub> -	R <sub>IN2</sub> +	AGND B8	R <sub>IN4</sub> -	R <sub>IN4</sub> +	B11	R <sub>IN6</sub> -	R <sub>IN6</sub> +	PGND B14
DV <sub>DD</sub>	DGND C2	DV <sub>DD</sub>	REF <sub>CLK</sub>	PWRDN C5	C6	AGND C7	AGND C8	AV <sub>DD</sub> B	C10	Q AGND	PGND C12	SEL2	DGND C14
TMS	TRST	CHTST	$DV_DD$	R <sub>IN 1</sub> -	R <sub>IN 1</sub> +	$AV_{DD}$	R <sub>IN3</sub> -	R <sub>IN3</sub> +	R <sub>IN5</sub> -	R <sub>IN5</sub> +	SELO	SEL 1	BIST_SEL2
D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D14
TDI E1	TCK E2	TDO E3	DGND E4	DGND E5	$OV_{DD}$	DGND E7	BIST_SEL0	DGND E9	PGND E10	DGND E 1 1	(E12)	E13	BIST_SEL1
PVDD	R <sub>OUTO9</sub>	CHTST_EN	R <sub>OUTO8</sub>	DGND	DV <sub>DD</sub>	DV <sub>DD</sub>	DGND	DV <sub>DD</sub>	DV <sub>DD</sub>	N/C	R <sub>OUT57</sub>	R <sub>OUT58</sub>	R <sub>OUT59</sub>
F1	F2	F3	F4	F5	F6	F7	F8	F9	F10	F11	F12	F13	F14
PV <sub>DD</sub>	RCLK <sub>0</sub>	LOCK <sub>0</sub>	R <sub>OUT07</sub>	DGND	DGND	$DV_DD$	PGND	DGND	$DV_DD$	N/C	$DV_DD$	RCLK <sub>5</sub>	$PV_{DD}$
G1 PGND	G2 PGND	G3 R <sub>OUTO6</sub>	G4 ROUTO5	G5 DGND	G6 DV <sub>DD</sub>	G7 DGND	G8 DGND	G9 DGND	G10) DV <sub>DD</sub>	(G11) R <sub>OUT55</sub>	(G12) R <sub>OUT56</sub>	G13 PGND	G14 PV <sub>DD</sub>
(H1)	(H2)	(H3)	(H4)	(H5)	(H6)	(H7)	(H8)	(H9)	(H 1 0)	(H 1 1)	(H12)	(H13)	(H 14)
PGND	R <sub>OUTO4</sub>	R <sub>OUTO 2</sub>	R <sub>OUTO3</sub>	DGND	$DV_DD$	DGND	DGND	DGND	$DV_DD$	R <sub>OUT54</sub>	R <sub>OUT53</sub>	PGND	PGND
J1 PV <sub>DD</sub>	$\bigcup_{D} J2$	J3	J4 PGND	J5 DV <sub>DD</sub>	J6 DGND	J7 DGND	DV <sub>DD</sub>	DA <sup>DD</sup>	J10 DV <sub>DD</sub>	(J11)	(J12)	J13 PGND	J14 PV <sub>DD</sub>
(K1)	R <sub>OUT12</sub>	R <sub>OUT 10</sub>	(K4)	K5	(K6)	(K7)	(K8)	K9	(K10)	R <sub>OUT52</sub>	R <sub>OUT51</sub>	(K13)	(K14)
$PV_{DD}$	R <sub>OUT14</sub>	R <sub>OUTOO</sub>	R <sub>OUTO1</sub>	$DV_{DD}$	$DV_{DD}$	$DV_{DD}$	DGND	DGND	$DV_{DD}$	BIST_ACT	R <sub>OUT50</sub>	R <sub>OUT40</sub>	$PV_{DD}$
(L1)	L2	(L3)	L4)	L5)	(re)	L7	(L8)	(L9)	(L10)	(L11)	(L12)	(L13)	(L14)
R <sub>OUT 13</sub>	RCLK <sub>1</sub>	R <sub>OUT 1 1</sub>	N/C	N/C M5	R <sub>OUT21</sub>	DGND M7	R <sub>OUT31</sub>	R <sub>OUT34</sub>	M10	R <sub>OUT45</sub>	R <sub>OUT41</sub>	R <sub>OUT44</sub>	R <sub>OUT42</sub>
R <sub>OUT 15</sub>	R <sub>OUT 18</sub>	R <sub>OUT 19</sub>	R <sub>OUT29</sub>	R <sub>OUT25</sub>	R <sub>OUT23</sub>	R <sub>OUT20</sub>	R <sub>OUT30</sub>	R <sub>OUT33</sub>	R <sub>OUT35</sub>	R <sub>OUT36</sub>	R <sub>OUT46</sub>	RCLK <sub>4</sub>	R <sub>OUT43</sub>
N <sub>1</sub>	N2	N3	N4	N5	N6	N7	N8	N9	N 1 0	N 1 1	N12	N13	N 1 4
R <sub>OUT16</sub>	R <sub>OUT 17</sub>	LOCK <sub>2</sub>	R <sub>OUT27</sub>	RCLK <sub>2</sub>	R <sub>OUT22</sub>	PGND	PGND	R <sub>OUT32</sub>	RCLK <sub>3</sub>	R <sub>OUT37</sub>	R <sub>OUT39</sub>	R <sub>OUT47</sub>	R <sub>OUT48</sub>
P1 LOCK <sub>1</sub>	P2 R <sub>OUT28</sub>	(P3) R <sub>OUT 26</sub>	R <sub>OUT24</sub>	P5 PV <sub>DD</sub>	P6 PV <sub>DD</sub>	P7 PGND	P8 PGND	P9 PV <sub>DD</sub>	P10 PV <sub>DD</sub>	(P11) R <sub>OUT38</sub>	P12 LOCK <sub>3</sub>	P13 LOCK	(P14) R <sub>OUT49</sub>
'	00120	00120	00124	00	00			00	55	00100	3	4	20014714

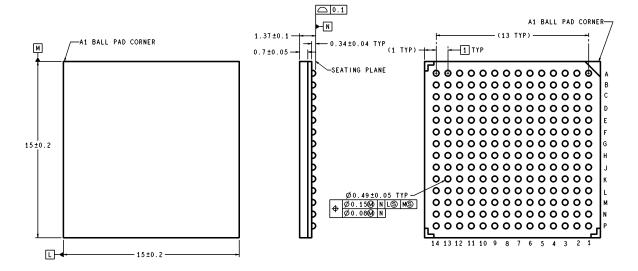
## **Pin Descriptions**

Pin Name	Туре	Pins	Description
SEL (0:2)	CMOS Input	B13, C12, C13	These pins control which Bus LVDS input is steered to the CHTST output. The Control Pins Truth Table describes their function. There are weak internal pull-ups that should default all SEL(0:2) to high. For example, if you choose not to use Channel Test Mode and want the CHTST output permanently disabled, you can tie SEL2 and SEL1 high and SEL0 low. In a noisy operating environment, it is recommended that an external pull up be used to ensure that SELn is in the high state.
Rin +/- n	Bus LVDS Input	A4-A3, A7-A6, A10-A9, A13-A12, C6-C5, C9-C8, C11-C10,	Bus LVDS differential input pins
AGND		A5, A8, B7, B8, B11	Analog Ground
AVDD		A11, B6, B9, C7	Analog Voltage Supply
PWRDN	CMOS Input	B5	A low on this pin puts the device into sleep mode and a high makes the part active.  There is an internal pull-down that defaults PWRDN to sleep mode. Active operation requires asserting a high on PWRDN.
REN	CMOS Input	A2	Enables the Routn and RCLKn outputs. There is an internal pull-down that defaults REN to TRI-STATE the outputs. Active outputs require asserting a high on REN.
REFCLK	CMOS Input	B4	Frequency reference clock input.
CHTST	CMOS Output	C3	Allows low speed testing of the Rin inputs under control of the SEL (0:2) pins.
LOCK (0:5)	CMOS Output	F3, P1, N3, P12, P13, D13	Indicates the status of the PLLs for the individual deserializers: $\overline{LOCK} = L$ indicates locked, $\overline{LOCK} = H$ indicates unlocked.
Rout nx	CMOS Output	E2, E4, E12, E13, E14, F4, G3, G4, G11, G12, H2, H3, H4, H11, H12, J2, J3, J11, J12, K2, K3, K4, K12, K13, L1, L3, L6, L8, L9, L11, L12, L13, L14, M1, M2, M3, M4, M5, M6, M7, M8, M9, M10, M11, M12, M14, N1, N2, N4, N6, N9, N11, N12, N13, N14, P2, P3, P4, P11, P14	Outputs for the ten bit deserializers, n = deserializer number, x = bit number
RCLK (0:5)	CMOS Output	F2, F13, L2, M13, N5, N10	Recovered clock for each deserializer's output data.
DVDD		B1, B3, C4, D6, D12, E6, E7, E9, E10, F7, F10, F12, G6, G10, H6, H10, J5, J8, J9, J10, K5, K6, K7, K10, L10	Digital Supply Voltage.
DGND		A1, B2, B14, D4, D5, D7, D9, D11, E5, E8, F5, F6, F9, G5, G7, G8, G9, H5, H7, H8, H9, J6, J7, K8, K9, L7	Digital Ground.
PVDD		E1, F1, F14, G14, J1, J14, K1, K14, P5, P6, P9, P10	PLL Supply Voltage.
PGND		A14, B12, D10, F8, G1, G2, G13, H1, H13, H14, J4, J13, N7, N8, P7, P8	PLL Ground.

## Pin Descriptions (Continued)

Pin Name	Type	Pins	Description
TMS	CMOS Input	C1	Test Mode Select input to support IEEE 1149.1
TRST	CMOS Input	C2	Test Reset Input to support IEEE 1149.1
TDI	CMOS Input	D1	Test Data Input to support IEEE 1149.1
TCK	CMOS Input	D2	Test Clock to support IEEE 1149.1
TDO	CMOS Output	D3	Test Data Output to support TDO
BISTMODE_REQ	CMOS Input	B10	BIST Alone Error Reporting Mode Select Input
BIST_SEL(0:2)	CMOS Input	C14, D8, D14	These pins control which channels are active for the BIST Alone operation mode. The BIST Alone Mode Selection Table describes their function. There are internal pull-ups that default all BIST_SEL(0:2) to high, which is the idle state for all channels in BIST Alone mode.
CHTST_EN	CMOS Input	E3	A high on this input enables the CHTST output. There is an internal pull-up that defaults the CHTST output to the active mode. Note: CHTEST_EN requires two clock cycles before CHTST is enabled or disabled. When not using CHTST output, assert a low on this control pin to reduce power consumption.
BIST_ACT	CMOS Input	K11	A high on this pin activates the BIST Alone operating mode. There is a weak internal pull-down that should default the BIST_ACT to de-activate the BIST Alone operating mode. In a noisy operating environment, it is recommended that an external pull down be used to ensure that BIST_ACT is in the low state.
N/C		E11, F11, L4, L5	Unused solder ball location. Do not connect.

## Physical Dimensions inches (millimeters) unless otherwise noted



DIMENSIONS ARE IN MILLIMETERS

UJB196A (Rev B)

Order Number SCAN921260UJB (Tray)
Order Number SCAN921260UJBX (Tape and Reel)
NS Package Number UJB196A

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